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REMARKS

This paper responds to the Office Action mailed on December 16, 2003. Claims 36, 38, 39, 44 and 49 are amended and claims 64 and 65 are cancelled such that claims 36-42, 44-47, 49-60 and 62-63 are now pending in this application.

Allowable Subject Matter

Claims 37 and 51-57 were allowed. Applicant has incorporated the limitations indicated as allowable by the Examiner from claims 37 and 51 into claims 36, 38-42, 44-47, 49, 50, 58-60, and 62-63 such that allowance of claims 36, 38-42, 44-47, 49, 50, 58-60, and 62-63 is respectfully requested.

§103 Rejection of the Claims

Claims 36, 38-42, 44-47, 49, 50, 58-60, and 62-65 were rejected under 35 USC § 103(a) as being unpatentable over Fogal et al. (U.S. 5,140,404) taken in view of Sawamura et al. (U.S. 6,303,219) and optionally the admitted state of the prior art. As discussed above, Applicant has incorporated the limitations indicated as allowable by the Examiner from claims 37 and 51 into claims 36, 38-42, 44-47, 49, 50, 58-60, and 62-63.

Reconsideration and allowance of claims 36, 38-42, 44-47, 49-50, 58-60 & 62-63 are respectfully requested.

Reservation of Right to file Continuation Application

Applicant respectfully traverses the pending 35 USC § 103 rejection. Applicant reserves the right to file a continuation application relating to any of the cancelled, original, or previously pending claims at a later date. Applicant also respectfully reserves the right to traverse the statements in the Office Action relating to the rejection (e.g., under MPEP 2144.04 among other things). Applicant is expressly not admitting to any assertions made in the Office Action.

Reservation of Right to Swear Behind References

Applicant reserves the right to swear behind any references which are cited in a rejection under 35 U.S.C. §§102(a), 102(e), 103/102(a), and 103/102(e). Statements distinguishing the

AMENDMENT AND RESPONSE UNDER 37 CFR § 1.116 - EXPEDITED PROCEDURE

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claimed subject matter over the cited references are not to be interpreted as admissions that the references are prior art.

Examiner Interview

Applicant's attorney, Andrew Peret, would like to thank Examiner Knable for his courtesy during the telephone interview held on January 28, 2004. Examiner Knable and Applicant's attorney, Andrew Peret, discussed the cited references and claims.

Examiner Knable indicated that amending the previously pending claims to include "wherein the first adhesive layer has a first coefficient of thermal expansion substantially identical to that of the organic support structure" and "wherein the second adhesive layer has a second coefficient of thermal expansion substantially identical to that of the semiconductor die" would be allowable. Applicant reserves the right to file a continuation application relating to such claims at a later date.

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CONCLUSION

Applicant respectfully submits that the claims are in condition for allowance and notification to that effect is earnestly requested. The Examiner is invited to telephone Applicant's attorney (612) 373-6951 to facilitate prosecution of this application.

If necessary, please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

Respectfully submitted,

EDWARD A. SCHROCK ET AL.

By their Representatives,

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

P.O. Box 2938

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(612) 373-6951

Date Feb. 13, 2004

Suneel Arora Reg. No. 42,267

<u>CERTIFICATE UNDER 37 CFR 1.8:</u> The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Mail Stop AF, Commissioner of Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this <u>12th</u> day of <u>February</u>, 2004.

Name

Signature